Electronic Pate	ent App	lication Fe	e Transı	nittal			
Application Number:	10	10772064					
Filing Date:	03	03-Feb-2004					
Title of Invention:		ALTERNATIVE FLIP CHIP IN LEADED MOLDED PACKAGE DESIGN AND METHOD FOR MANUFACTURE					
First Named Inventor/Applicant Name:	Ro	Romel N. Manatad					
Filer:	Pa	Patrick Raymond Jewik/Andrea Beck					
Attorney Docket Number:	01	018865-012810US					
Filed as Large Entity	•						
Utility Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:					1		
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Utility Appl Issue fee		1501	1	1400	1400		

Publ. Fee- early, voluntary, or normal

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:				
Miscellaneous:				
	Total in USD (\$)			1700